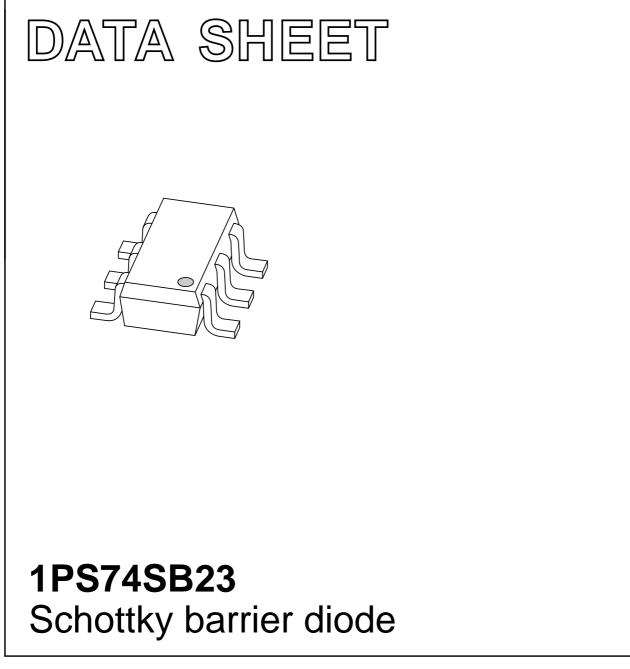
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 Aug 27 2003 Aug 04



FEATURES

- Ultra fast switching speed
- Low forward voltage
- · Fast recovery time
- Guard ring protected
- Small plastic SMD package
- Capability of absorbing very high surge current.

APPLICATIONS

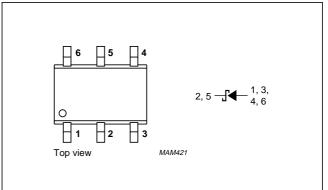
- Rectification
- Circuit protection
- · Polarity protection
- Switched-mode power supplies.

DESCRIPTION

Planar Schottky barrier diode encapsulated in an SC-74 (SOT457) small plastic SMD package.

PINNING		
	PIN	

1	anode
2	cathode
3	anode
4	anode
5	cathode
6	anode



Marking code: P1.

Fig.1 Simplified outline SC-74 (SOT457) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		_	25	V
I _F	continuous forward current		_	1	А
I _{FSM}	non-repetitive peak forward current	t _p = 8.3 ms; half sinewave; JEDEC method; note 1	-	25	A
I _{RSM}	non-repetitive peak reverse current $t_p = 100 \ \mu s$		_	0.5	А
T _{stg}	storage temperature		-65	+150	О°
Tj	junction temperature		_	125	°C

Note

1. Pins 1, 3, 4 and 6 are connected in parallel; pins 2 and 5 are connected in parallel.

1PS74SB23

DESCRIPTION

1PS74SB23

ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 100 mA	260	300	mV
		I _F = 1 A	400	450	mV
I _R	reverse current	$V_R = 20 V$; note 1; see Fig.3	80	500	μΑ
		$V_R = 25 V$; note 1; see Fig.3	-	1	mA
C _d	diode capacitance	$f = 1 MHz; V_R = 4 V; see Fig.4$	100	_	pF

Note

1. Pulse test: $t_p = 300 \ \mu s$; $\delta = 0.02$.

THERMAL CHARACTERISTICS

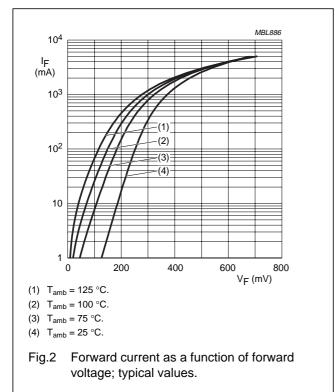
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	250	K/W

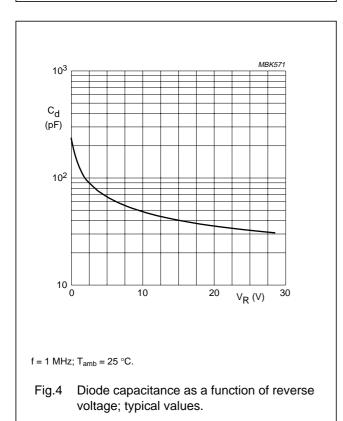
Note

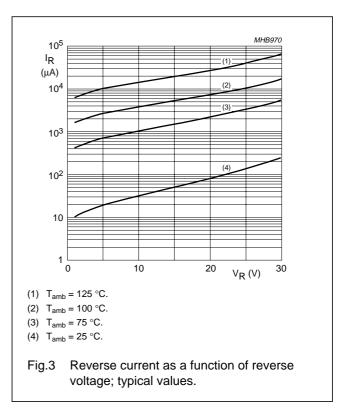
1. Refer to SC-74 (SOT457) standard mounting conditions.

1PS74SB23

GRAPHICAL DATA





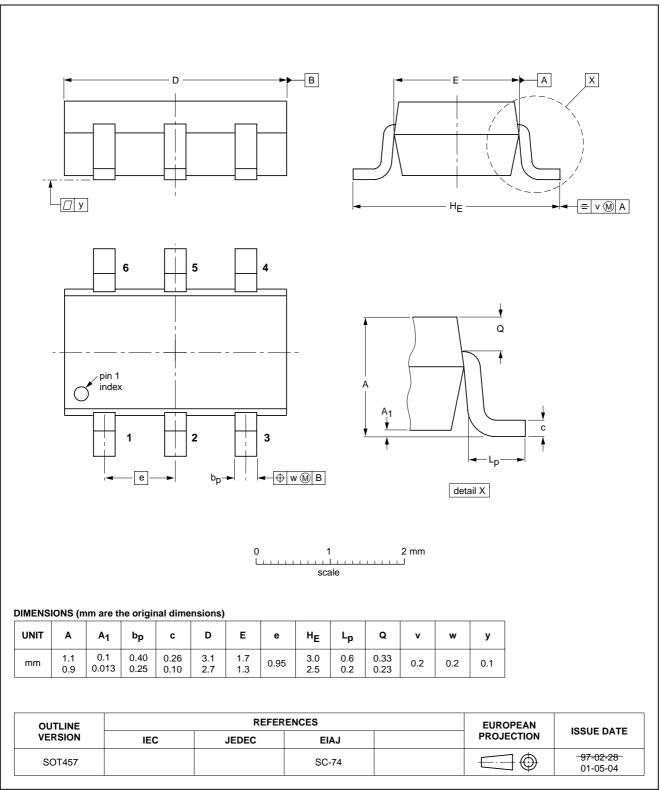


1PS74SB23

Schottky barrier diode

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads



SOT457

1PS74SB23

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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